

6A, 400 - 600V High Efficient Surface Mount Rectifiers

FEATURES

- AEC-Q101 qualified
- Glass passivated junction chip
- · Low power loss, high efficiency
- · Fast switching for high efficiency
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switch Mode Power Supply
- Inverters and Converters
- Free Wheeling diodes

MECHANICAL DATA

- Case: SMPC4.6U
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.104 g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
$I_{F(AV)}$	6	А	
V_{RRM}	400-600	V	
I _{FSM}	140	Α	
T_{JMAX}	175	ů	
Package	SMPC4.6U		
Configuration	Single		



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	TUAU6GH	TUAU6JH	UNIT
Marking code on the device			AU6GH	AU6JH	
Repetitive peak reverse volta	ge	V_{RRM}	400	600	V
Reverse voltage, total rms value		V _{R(RMS)}	280	420	V
Forward current		I _F	6		А
Surge peak forward current single half sine-wave	8.3 ms at T _A = 25°C	I _{ESM}	140		A
superimposed on rated load	1.0 ms at T _A = 25°C	'FSM	230		
Junction temperature		TJ	-55 to	+175	°C
Storage temperature T _{STG} -55 to +1		+175	°C		



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	R _{OJL}	6	°C/W
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	50	°C/W
Junction-to-case thermal resistance	R _{eJC}	9	°C/W

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage (1)	I _F = 3.0A, T _J = 25°C	- V _F	1.05	-	V
	I _F = 6.0A, T _J = 25°C		1.17	1.3	V
	I _F = 3.0A, T _J = 125°C		0.84	-	V
	I _F = 6.0A, T _J = 125°C		0.98	1.21	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C		-	5	μA
	T _J = 125°C	- I _R	-	100	μA
Junction Capacitance	1 MHz, V _R =4.0V	C _j	64	-	pF
Maximum reverse recovery time	I _F =0.5A , I _R =1.0A I _{RR} =0.25A	t _{rr}	-	50	nS

Notes:

- (1) Pulse test with PW=0.3 ms
- (2) Pulse test with PW=30 ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING		
TUAU6xH M3G	SMPC4.6U	1,500 / 7" reel		
TUAU6xH M2G	SMPC4.6U	6,000 / 13" reel		

Notes:

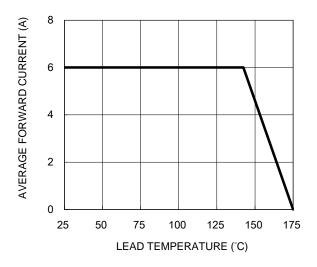
(1) "x" defines voltage from 400V(TUAU6GH) to 600V(TUAU6JH)

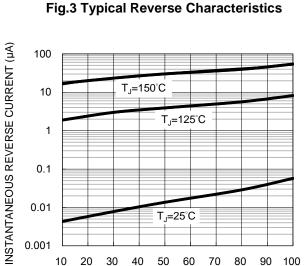


CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve





PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

20 30 40 50 60 70 80 90

Fig.2 Typical Junction Capacitance

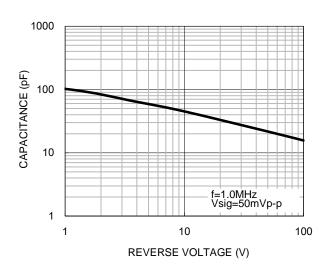


Fig.4 Typical Forward Characteristics

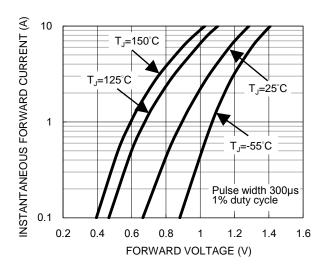
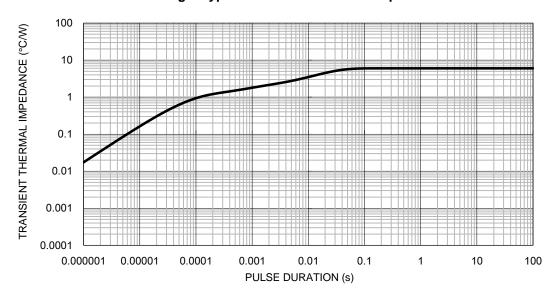


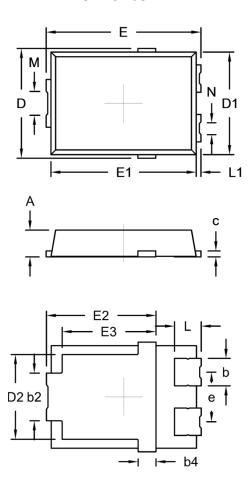
Fig.5 Typical Transient Thermal Impedance





PACKAGE OUTLINE DIMENSIONS

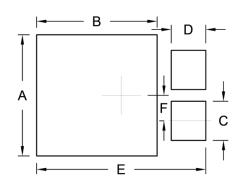
SMPC4.6U



DIM.	Unit (mm)		Unit (inch)
	Min.	Max.	Min.	Max.
Α	1.00	1.20	0.039	0.047
b	1.05	1.35	0.041	0.053
b2	1.90	2.20	0.075	0.087
b4	0.75 (NOM.)	0.030	(NOM.)
С	0.15	0.40	0.006	0.016
D	4.45	4.75	0.175	0.187
D1	4.25	4.35	0.167	0.171
D2	3.40	3.70	0.134	0.146
E	6.35	6.65	0.250	0.262
E1	6.05	6.15	0.238	0.242
E2	4.40	4.80	0.173	0.189
E3	3.94 (NOM.)		0.155	(NOM.)
е	2.08 (NOM.)		0.082 (NOM.)	
L	0.94	1.24	0.037	0.049
L1	0.05	0.35	0.002	0.014
М	0.65	1.15	0.026	0.045
N	0.25	0.75	0.010	0.030

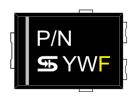
Package body size D1 and E1 do not include mold flash Mold flash shall not exceed 0.1mm per side

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	4.95	0.195
В	4.95	0.195
С	1.60	0.063
D	1.42	0.056
E	6.95	0.274
F	1.04	0.041

MARKING DIAGRAM



P/N = Marking Code ΥW = Date Code F = Factory Code

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